# Onsemi

# **Industrial Inductive Load Driver**

# NUD3160, SZNUD3160

This micro-integrated part provides a single component solution to switch inductive loads such as relays, solenoids, and small DC motors without the need of a free-wheeling diode. It accepts logic level inputs, thus allowing it to be driven by a large variety of devices including logic gates, inverters, and microcontrollers.

### Features

- Provides Robust Interface between D.C. Relay Coils and Sensitive Logic
- Capable of Driving Relay Coils Rated up to 150 mA at 12 V, 24 V or 48 V
- Replaces 3 or 4 Discrete Components for Lower Cost
- Internal Zener Eliminates Need for Free–Wheeling Diode
- Meets Load Dump and other Automotive Specs
- SZ Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and **PPAP** Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

#### **Typical Applications**

- Automotive and Industrial Environment
- Drives Window, Latch, Door, and Antenna Relays

#### **Benefits**

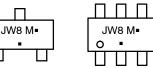
- Reduced PCB Space
- Standardized Driver for Wide Range of Relays
- Simplifies Circuit Design and PCB Layout
- Compliance with Automotive Specifications



SOT-23 **CASE 318** STYLE 21

SC-74 **CASE 318F** STYLE 7





- JW8 = Specific Device Code Μ = Date Code
  - = Pb-Free Package

(Note: Microdot may be in either location)

Μ = Date Code

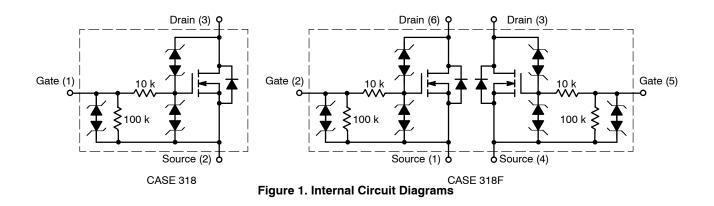
= Pb-Free Package

(Note: Microdot may be in either location)

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
NUD3160LT1G	SOT-23 (Pb-Free)	3000 / Tape & Reel
SZNUD3160LT1G	SOT-23 (Pb-Free)	3000 / Tape & Reel
NUD3160DMT1G	SC–74 (Pb–Free)	3000 / Tape & Reel
SZNUD3160DMT1G	SC-74 (Pb-Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



#### **MAXIMUM RATINGS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise specified)

Symbol	Rating	Value	Unit
V <sub>DSS</sub>	Drain-to-Source Voltage - Continuous (T <sub>J</sub> = 125°C)	60	V
V <sub>GSS</sub>	Gate-to-Source Voltage – Continuous (T <sub>J</sub> = 125°C)	12	V
ID	Drain Current – Continuous ( $T_J = 125^{\circ}C$ ) Minimum copper, double sided board, $T_A = 80^{\circ}C$ SOT-23 SC74 Single device driven SC74 Both devices driven 1 in <sup>2</sup> copper, double sided board, $T_A = 25^{\circ}C$ SOT-23 SC74 Single device driven SC74 Both devices driven	158 157 132 ea 272 263 230 ea	mA
EZ	Single Pulse Drain-to-Source Avalanche Energy (For Relay's Coils/Inductive Loads of 80 $\Omega$ or Higher) (T <sub>J</sub> Initial = 85°C)	200	mJ
P <sub>PK</sub>	Peak Power Dissipation, Drain-to-Source (Notes 1 and 2) (T <sub>J</sub> Initial = 85°C)	20	W
E <sub>LD1</sub>	Load Dump Pulse, Drain-to-Source (Note 3) $R_{SOURCE} = 0.5 \Omega$ , T = 300 ms) (For Relay's Coils/Inductive Loads of 80 $\Omega$ or Higher) (T <sub>J</sub> Initial = 85°C)	60	V
E <sub>LD2</sub>	Inductive Switching Transient 1, Drain-to-Source (Waveform: $R_{SOURCE} = 10 \Omega$ , T = 2.0 ms) (For Relay's Coils/Inductive Loads of 80 $\Omega$ or Higher) (T <sub>J</sub> Initial = 85°C)	100	V
E <sub>LD3</sub>	Inductive Switching Transient 2, Drain-to-Source (Waveform: $R_{SOURCE} = 4.0 \Omega$ , T = 50 µs) (For Relay's Coils/Inductive Loads of 80 $\Omega$ or Higher) (T <sub>J</sub> Initial = 85°C)	300	V
Rev-Bat	Reverse Battery, 10 Minutes (Drain-to-Source) (For Relay's Coils/Inductive Loads of 80 Ω or more)	-14	V
Dual-Volt	Dual Voltage Jump Start, 10 Minutes (Drain-to-Source)	28	V
ESD	Human Body Model (HBM) According to EIA/JESD22/A114 Specification	2000	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### **THERMAL CHARACTERISTICS**

Symbol	Rating		Unit	
T <sub>A</sub>	Operating Ambient Temperature	-40 to 125	°C	
Τ <sub>J</sub>	Maximum Junction Temperature	150	°C	
T <sub>STG</sub>	Storage Temperature Range	-65 to 150	°C	
PD	Total Power Dissipation (Note 4) SOT-23   Derating above 25°C SOT-23	225 1.8	mW mW/°C	
PD	Total Power Dissipation (Note 4) SC-74   Derating above 25°C SC-74	380 3.0	mW mW/°C	
$R_{ hetaJA}$	Thermal Resistance, Junction-to-Ambient Minimum Copper SC-74 One Device Powered SC-74 Both Devices Equally Powered	556	°C/W	
300 mm <sup>2</sup> Copper	300 mm <sup>2</sup> Copper SOT-23 SC-74 One Device Powered SC-74 Both Devices Equally Powered	395 420 270		

1. Nonrepetitive current square pulse 1.0 ms duration.

For different square pulse durations, see Figure 12.
Nonrepetitive load dump pulse per Figure 3.
Mounted onto minimum pad board.

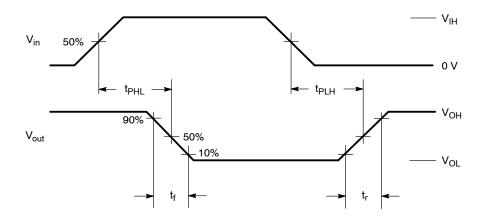
## **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise specified)

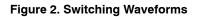
Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS					
Drain to Source Sustaining Voltage (I <sub>D</sub> = 10 mA)	V <sub>BRDSS</sub>	61	66	70	V
$      Drain to Source Leakage Current \\ (V_{DS} = 12 V, V_{GS} = 0 V) \\ (V_{DS} = 12 V, V_{GS} = 0 V, T_J = 125^{\circ}C) \\ (V_{DS} = 60 V, V_{GS} = 0 V) \\ (V_{DS} = 60 V, V_{GS} = 0 V, T_J = 125^{\circ}C) \\ \end{array} $	IDSS	- - -	- - - -	0.5 1.0 50 80	μΑ
Gate Body Leakage Current ( $V_{GS} = 3.0 \text{ V}, V_{DS} = 0 \text{ V}$ ) ( $V_{GS} = 3.0 \text{ V}, V_{DS} = 0 \text{ V}, T_J = 125^{\circ}\text{C}$ ) ( $V_{GS} = 5.0 \text{ V}, V_{DS} = 0 \text{ V}$ ) ( $V_{GS} = 5.0 \text{ V}, V_{DS} = 0 \text{ V}, T_J = 125^{\circ}\text{C}$ )	I <sub>GSS</sub>	- - -	- - -	60 80 90 110	μΑ
ON CHARACTERISTICS					
Gate Threshold Voltage $(V_{GS} = V_{DS}, I_D = 1.0 \text{ mA})$ $(V_{GS} = V_{DS}, I_D = 1.0 \text{ mA}, T_J = 125^{\circ}\text{C})$	V <sub>GS(th)</sub>	1.3 1.3	1.8 _	2.0 2.0	V
Drain to Source On-Resistance ( $I_D = 150 \text{ mA}, V_{GS} = 3.0 \text{ V}$ ) ( $I_D = 150 \text{ mA}, V_{GS} = 3.0 \text{ V}, T_J = 125^{\circ}\text{C}$ ) ( $I_D = 150 \text{ mA}, V_{GS} = 5.0 \text{ V}$ ) ( $I_D = 150 \text{ mA}, V_{GS} = 5.0 \text{ V}, T_J = 125^{\circ}\text{C}$ )	R <sub>DS(on)</sub>	- - -	- - -	2.4 3.7 1.8 2.9	Ω
Output Continuous Current ( $V_{DS} = 0.3 \text{ V}, V_{GS} = 5.0 \text{ V}$ ) ( $V_{DS} = 0.3 \text{ V}, V_{GS} = 5.0 \text{ V}, T_J = 125^{\circ}\text{C}$ )	I <sub>DS(on)</sub>	150 100	200 _		mA
Forward Transconductance $(V_{DS} = 12 \text{ V}, I_D = 150 \text{ mA})$	9fs	-	400	-	mmho
DYNAMIC CHARACTERISTICS			2	-	-
Input Capacitance (V <sub>DS</sub> = 12 V, V <sub>GS</sub> = 0 V, f = 10 kHz)	C <sub>iss</sub>	-	30	-	pf
Output Capacitance (V <sub>DS</sub> = 12 V, V <sub>GS</sub> = 0 V, f = 10 kHz)	C <sub>oss</sub>	-	14	-	pf
Transfer Capacitance (V <sub>DS</sub> = 12 V, V <sub>GS</sub> = 0 V, f = 10 kHz)	C <sub>rss</sub>	-	6.0	-	pf
SWITCHING CHARACTERISTICS	_	_	_	_	
Propagation Delay Times: High to Low Propagation Delay; Figure 2, $(V_{DS} = 12 \text{ V}, V_{GS} = 3.0 \text{ V})$ Low to High Propagation Delay; Figure 2, $(V_{DS} = 12 \text{ V}, V_{GS} = 3.0 \text{ V})$	t <sub>PHL</sub> t <sub>PLH</sub>		918 798		ns
High to Low Propagation Delay; Figure 2, (V <sub>DS</sub> = 12 V, V <sub>GS</sub> = 5.0 V) Low to High Propagation Delay; Figure 2, (V <sub>DS</sub> = 12 V, V <sub>GS</sub> = 5.0 V)	t <sub>PHL</sub> t <sub>PLH</sub>	-	331 1160	-	
Transition Times: Fall Time; Figure 2, (V <sub>DS</sub> = 12 V, V <sub>GS</sub> = 3.0 V) Rise Time; Figure 2, (V <sub>DS</sub> = 12 V, V <sub>GS</sub> = 3.0 V)	t <sub>f</sub> tr		2290 618		ns
Fall Time; Figure 2, (V $_{DS}$ = 12 V, V $_{GS}$ = 5.0 V) Rise Time; Figure 2, (V $_{DS}$ = 12 V, V $_{GS}$ = 5.0 V)	t <sub>f</sub> t <sub>r</sub>	_	622 600	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

### **TYPICAL WAVEFORMS**

(T<sub>J</sub> = 25°C unless otherwise specified)





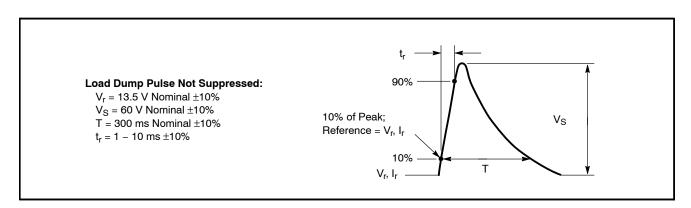
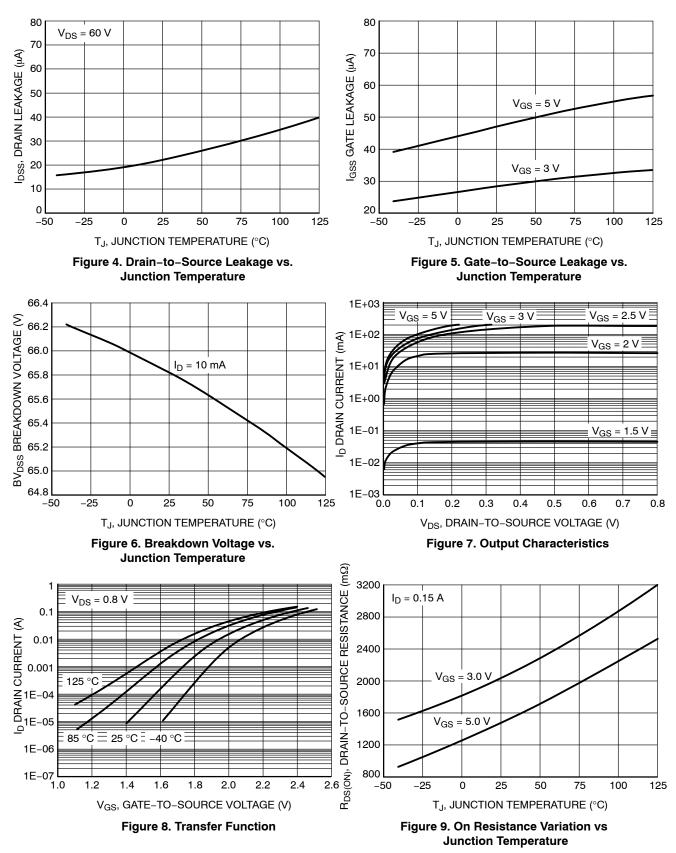


Figure 3. Load Dump Waveform Definition

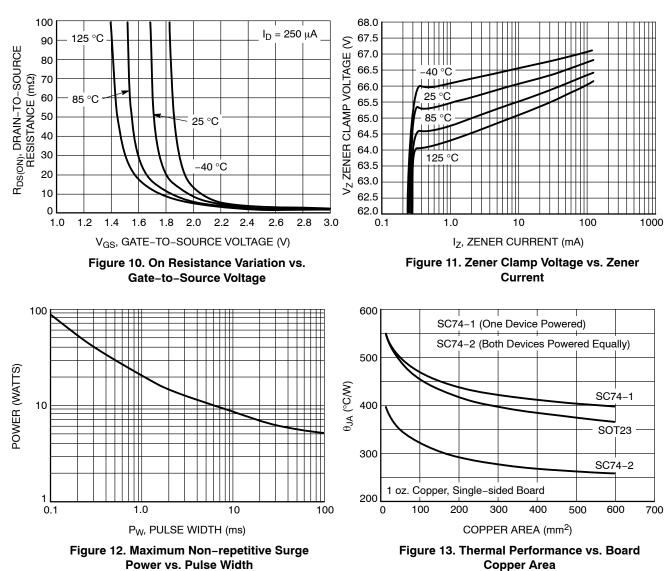
### **TYPICAL PERFORMANCE CURVES**

 $(T_J = 25^{\circ}C \text{ unless otherwise specified})$ 



## **TYPICAL PERFORMANCE CURVES**

 $(T_J = 25^{\circ}C \text{ unless otherwise specified})$ 



<u>www.onsemi.com</u> 6

# **APPLICATIONS INFORMATION**

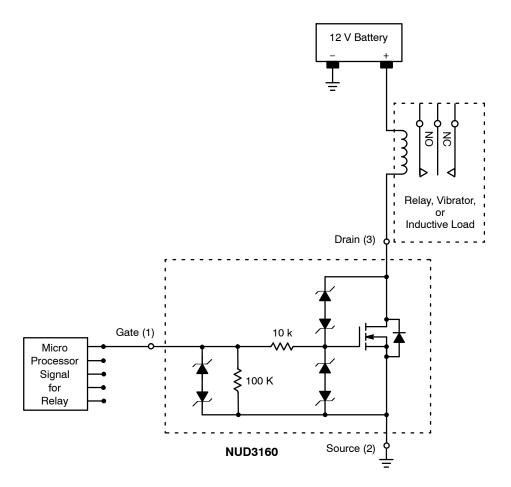
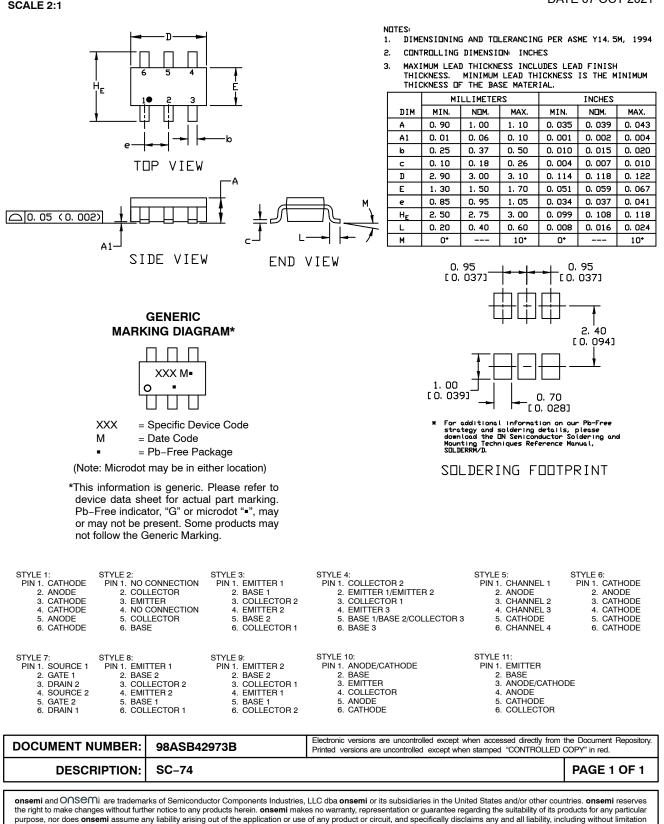


Figure 14. Applications Diagram

# onsemi

SC-74 CASE 318F ISSUE P

DATE 07 OCT 2021



special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent\_Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

#### ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at <u>www.onsemi.com/support/sales</u>